

Title (en)

Process for producing spray plated metal strip.

Title (de)

Verfahren zur Herstellung von spritzplattiertem Metallband.

Title (fr)

Procédé pour la production de bandes métalliques plaquées par pulvérisation.

Publication

EP 0463578 B1 19941221 (EN)

Application

EP 91110198 A 19910620

Priority

JP 16472790 A 19900621

Abstract (en)

[origin: EP0463578A1] A process for producing a spray-plated metal strip by spraying a molten metal on a metal strip, which comprises: spraying, on a metal strip, molten metal particles having a weight average particle diameter of not more than 15 times the thickness of a plated layer to be formed on the strip. <IMAGE>

IPC 1-7

C23C 4/12

IPC 8 full level

C23C 4/12 (2006.01); **C23C 4/14** (2006.01); **C23C 4/18** (2006.01)

CPC (source: EP)

C23C 4/123 (2016.01)

Citation (examination)

Patent Abstracts of Japan, vol.13, no.504; (13.11.89); C-653, (&JP-A-1-201456)

Cited by

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